



<http://ewh.ieee.org/conf/edtm/2022>

6th IEEE Electron Devices Technology and Manufacturing (EDTM) Conference, 2022

Theme: *“Innovations in Semiconductor Devices and Manufacturing for Sustainable Society”*

Oita, Japan, March 6th - 9th, 2022

The **IEEE Electron Devices Technology and Manufacturing (EDTM) Conference** 6th EDTM (Electron Devices Technology and Manufacturing) conference is a full four-day meeting to be held at Oita, Japan from March 6 to 9th, 2022, fully sponsored by the IEEE Electron Devices Society (EDS). As semiconductor technology scaling challenges continues to grow, so should the industries collaborative efforts to overcome them must increase. EDTM is intended to serve as a forum for the electron devices community to collaborate on topics ranging from devices, materials, and tools, to create new and innovative technologies. EDTM will provide the following new formats

Whether you are seeking to enhance brand recognition, reinforce your reputation as an industry leader, or establish a new business, EDTM 2022 sponsorship will enable you achieve your goals in this highly attended conference

Sponsorship Benefits:

All sponsors will be recognized in the EDTM 2022 official website and the Proceedings.

Sponsorship Packages

Diamond (JPY 2,000K*):

- Company logo projected during Plenary Session
- Company logo on all technical session starting slides
- Company logo with Large SIZE font at registration showing your company as Diamond sponsor.
- Plus, your company logo at the Reception and Poster Sessions
- 5 complementary full conference Registration
- 3 complementary Tutorial/Short Course Registration
- 3 complementary exhibition booths

Platinum (JPY 1,500K*):

- Company logo projected during Plenary Session
- Company logo on all technical session starting slides
- Company logo with Large SIZE font at registration showing your company as Platinum sponsor.
- Plus, your company logo at the Reception and Poster Sessions
- 3 complementary full conference Registration
- 2 complementary Tutorial/Short Course Registration
- 2 complementary exhibition booth

Gold (JPY 1,000K*):

- Company logo on all technical session starting slides
- Company logo at registration identifying your company as Gold sponsor
- Company logo at the Reception and Poster Sessions
- 1 complementary full conference Registration
- 1 complementary Tutorial/Short Course Registration
- 1 complementary exhibition booth

Silver (JPY 500K*):

- Company logo at Registration identifying your company sponsor
- Company logo at the Reception and Poster Sessions
- 1 complementary full conference Registration
- 1 complementary exhibition booth

Bronze (JPY 300K*):

- Company logo at Registration identifying your company sponsor
- Company logo at the Reception and Poster Sessions

General Chair:

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Sponsorships & Exhibition Co-Chairs

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Sponsorship Category

Sponsorship Level	Costs (JPY) *
Diamond	2,000K
Platinum	1,500K
Gold	1,000K
Silver	500K
Bronze	300K

Sponsorship Benefit Summary

Sponsorship Benefits	Diamond	Platinum	Gold	Silver	Bronze
Company logo projection at Plenary Session	Yes	Yes	No	No	No
Company logo on all technical session starting slides	Yes	Yes	Yes	No	No
Banner at Registration identifying your company sponsor	Yes	Yes	Yes	Yes	Yes
Company logo at the Reception and Poster Sessions	Yes	Yes	Yes	Yes	Yes
Number of complementary full conference Registration	5	3	1	1	0
Number of complementary Tutorial/Short Course Registration	3	2	1	0	0
Number of complementary exhibition booths	3	2	1	1	0

Sponsorship Items

Banquet Sponsor (JPY 300K*):

- Company logo at the Banquet or request us for other kinds of benefits such as drinks labelled with your company logo, or distributing novelties.

Coffee Break Sponsor (JPY 50K* /Day):

- Up to 1 Company logo at the each day Coffee Breaks (Coffee Breaks are planned twice per day.)
- One company can apply for the multiple days, up to 3 days.

Online Banner Sponsor (JPY 80K*/1 banner):

- W264 ×H 70 pixel banner with the link to your company website at the top page of the EDTM 2022 official website.

*Japanese Consumption Tax 10% will be added.

EDTM2022 will go **HYBRID** comprising of regular **in-Person (on-Site) meeting** with large attendance. Plus a **Virtual** component (all presentation, participation and exhibition) for those with travel restriction due to COVID-19.

Contact:

Sponsorships & Exhibition Co-Chairs

Shuji Ikeda: Shu.ikeda@tei-solutions.com

Aabid Husain: aabid@atomera.com

General Chair:

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